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MOSFET - Power, Single N-Channel, STD Gate, SO8FL

40 V, 1.3 mΩ, **195 A**

NTMFS1D3N04XM

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Small Footprint (5 x 6 mm) with Compact Design
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

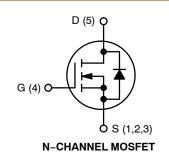
- Motor Drive
- Battery Protection
- ORing

MAXIMUM RATINGS (T_J = $25^{\circ}C$ unless otherwise stated)

Parameter	Symbol	Value	Unit	
Drain-to-Source Voltage	V _{DSS}	40	V	
Gate-to-Source Voltage	DC	V _{GS}	±20	V
Continuous Drain Current	$T_{C} = 25^{\circ}C$	I _D	195	А
	$T_{C} = 100^{\circ}C$		138	
Power Dissipation	$T_{C} = 25^{\circ}C$	PD	90	W
Continuous Drain Current	$T_A = 25^{\circ}C$	I _{DA}	40	А
$R_{ heta JA}$	$T_A = 100^{\circ}C$		28	
Pulsed Drain Current	T _C = 25°C, t _p = 10 μs	I _{DM}	1175	A
Operating Junction and Storag Range	T _J , T _{STG}	–55 to +175	°C	
Source Current (Body Diode)	I _S	74.5	А	
Single Pulse Avalanche Energ (I _{PK} = 11.1 A)	E _{AS}	306	mJ	
Lead Temperature for Solderin (1/8" from case for 10 s)	ΤL	260	°C	

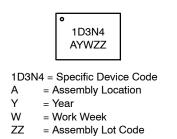
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX	
40 V	1.3 m Ω @ V _{GS} = 10 V	195 A	





SO-8FL CASE 488AA (DFN5)



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

THERMAL CHARACTERISTICS

Reverse Recovery Charge

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Note 2)	$R_{ ext{ heta}JC}$	1.67	°C/W
Thermal Resistance, Junction-to-Ambient (Notes 1, 2)	R_{\thetaJA}	40.1	

1. Surface mounted on FR4 board using 650 mm², 2 oz Cu pad.

2. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS		•		•		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 1 mA, T _J = 25°C	40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS}/ \Delta T_J$	I _D = 1 mA, Referenced to 25°C		15		mV/∘C
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 40 V, T_{J} = 25°C			10	μA
		V_{DS} = 40 V, T_{J} = 125°C			100	1
Gate-to-Source Leakage Current	I _{GSS}	V_{GS} = 20 V, V_{DS} = 0 V			100	nA
ON CHARACTERISTICS						
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I _D = 20 A, T _J = 25°C		1.17	1.3	mΩ
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 100 μ A, T_J = 25°C	2.5		3.5	V
Gate Threshold Voltage Temperature Coefficient	$\Delta V_{GS(TH)}/ \Delta T_J$	V_{GS} = V_{DS} , I_D = 100 μ A		-7.23		mV/∘C
Forward Trans-conductance	9FS	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		105		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE				-	-
Input Capacitance	C _{ISS}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		2459		pF
Output Capacitance	C _{OSS}			1578		
Reverse Transfer Capacitance	C _{RSS}			23.3		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DD} = 32 V; I_D = 50 A		38.6		nC
Threshold Gate Charge	Q _{G(TH)}			7.2		-
Gate-to-Source Charge	Q _{GS}			11.3		
Gate-to-Drain Charge	Q _{GD}			7.4		
Gate Resistance	R _G	f = 1 MHz		0.72		Ω
SWITCHING CHARACTERISTICS		•				
Turn-On Delay Time	t _{d(ON)}	Resistive Load,		19.1		ns
Rise Time	t _r	$V_{GS} = 0/10 \text{ V}, V_{DD} = 32 \text{ V},$ $I_D = 50 \text{ A}, \text{ R}_G = 0 \Omega$		6.2		
Turn-Off Delay Time	t _{d(OFF)}			30.4		-
Fall Time	t _f			5.2		
SOURCE-TO-DRAIN DIODE CHARACTI	ERISTICS	•	•	•	•	-
Forward Diode Voltage	V _{SD}	V_{GS} = 0 V, I _S = 20 A, T _J = 25°C		0.8		V
		V_{GS} = 0 V, I _S = 20 A, T _J = 125°C		0.65		-1
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, I _S = 50 A,		50		ns
Charge Time	ta	$dI/dt = 100 \text{ A}/\mu \text{s}, \text{ V}_{\text{DD}} = 32 \text{ V}$		24		1
Discharge Time	t _b	1		26		1

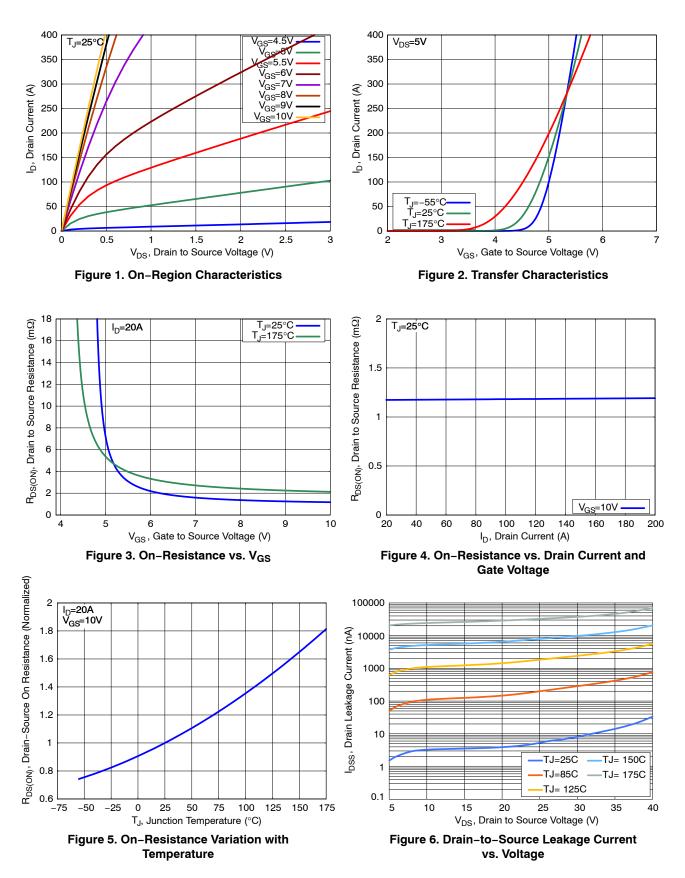
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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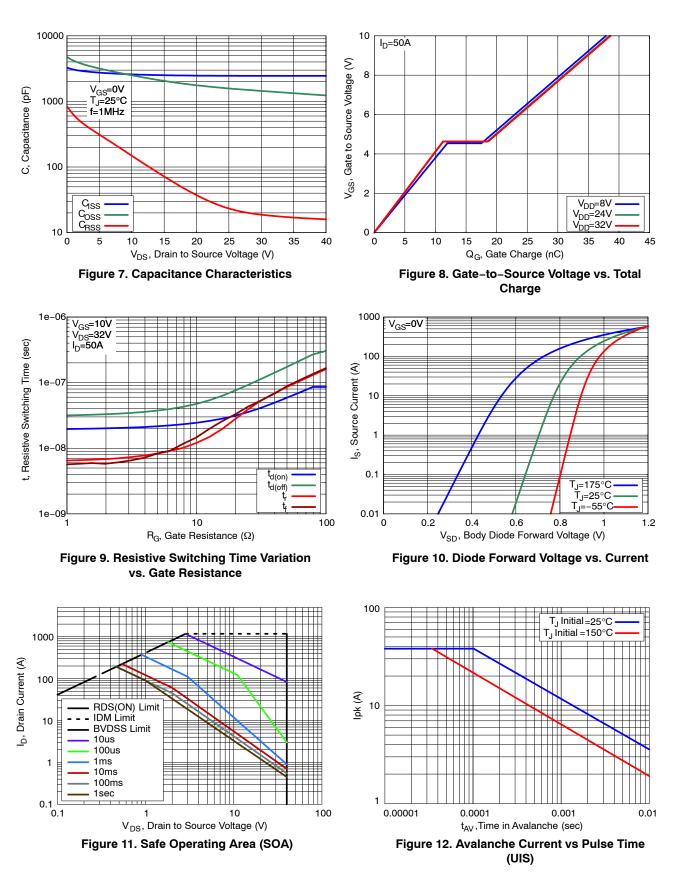
nC

 $\mathsf{Q}_{\mathsf{R}\mathsf{R}}$

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

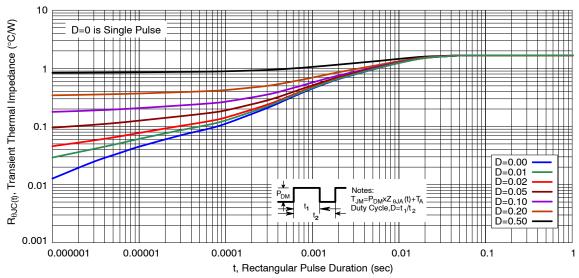


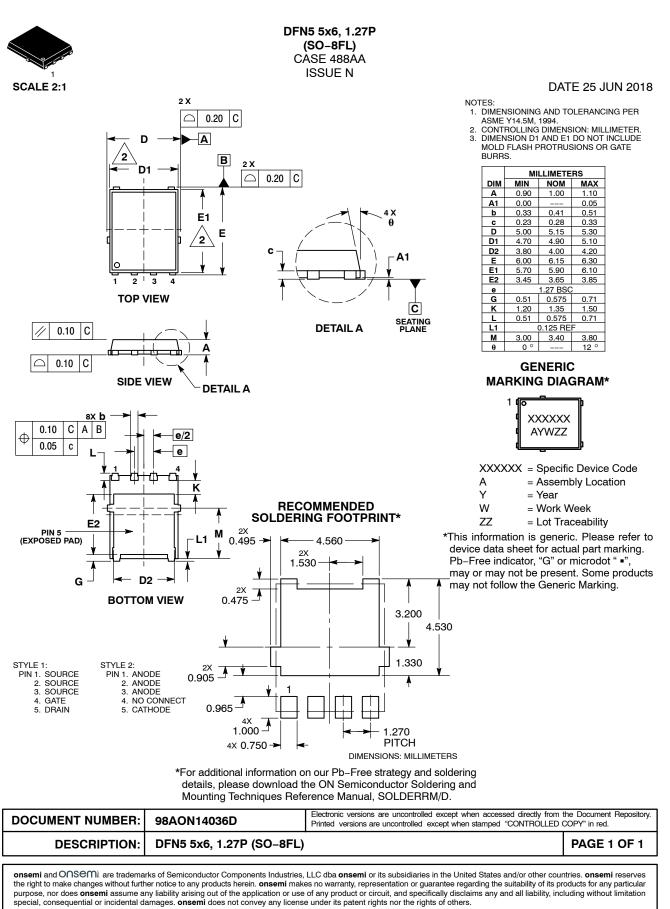
Figure 13. Transient Thermal Response

ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFS1D3N04XMT1G	1D3N4	SO–8FL (DFN5) (Pb–Free)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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